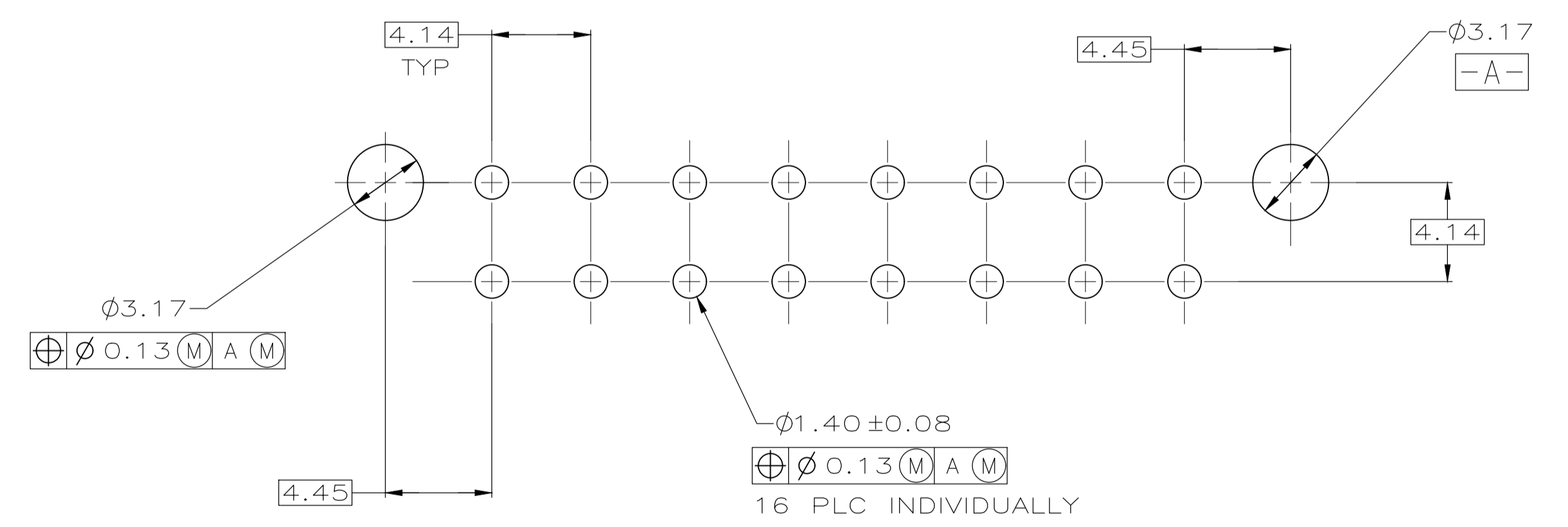
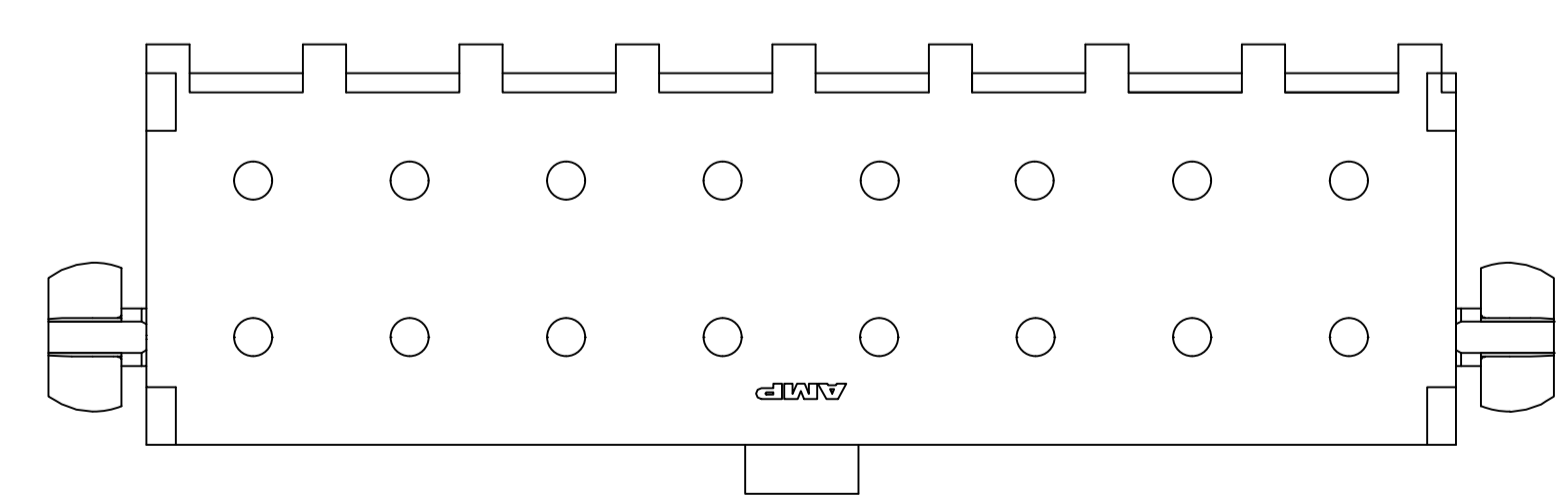
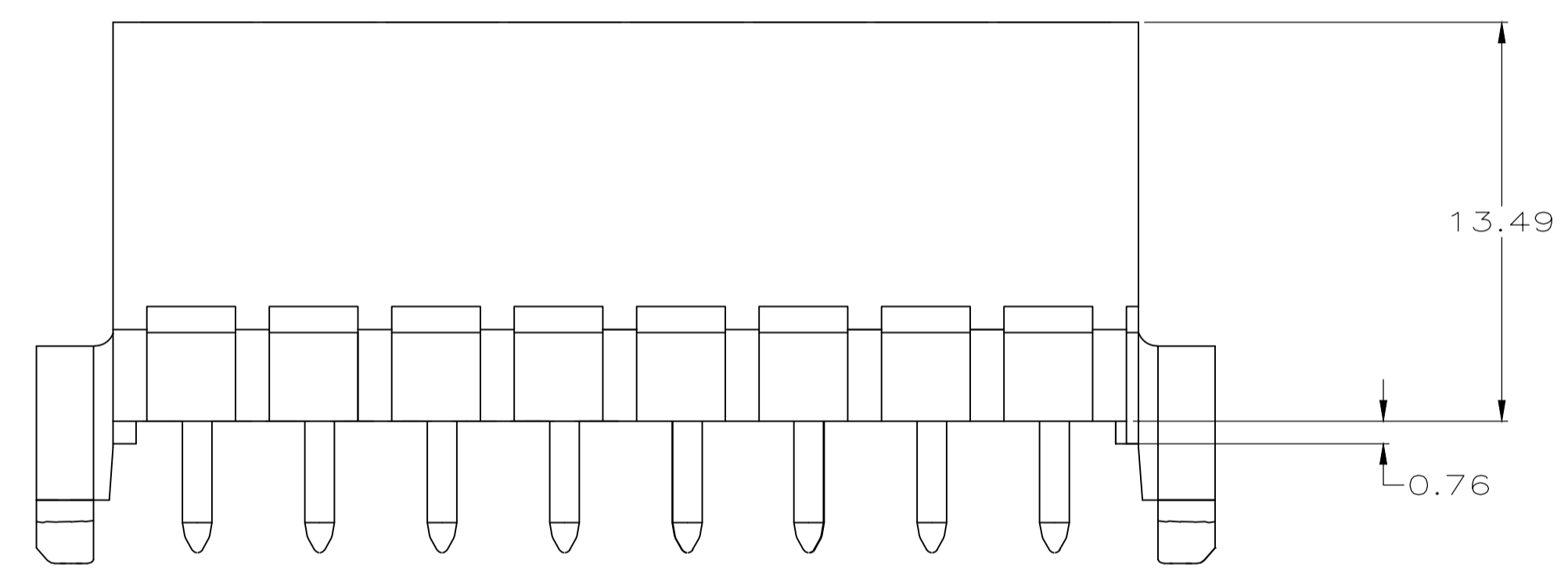


- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 108-11-3.
- 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
- 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
- 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

	BRASS, GOLD	5	NYLON, UL94V-0	WHITE	1-794075-1
	BRASS, TIN	4	NYLON, UL94V-0	WHITE	1-794075-0
OBSOLETE	BRASS, GOLD	3	NYLON, UL94V-0	WHITE	794075-2
	BRASS, TIN-LEAD	2	NYLON, UL94V-0	WHITE	794075-1
	MATERIAL	FINISH	MATERIAL	COLOR	PART NO.
	PIN		HOUSING		

THIS DRAWING IS A CONTROLLED DOCUMENT.

DMN: S CARPENTER	09JUN05	TE Connectivity NAME: HEADER ASSEMBLY, CLOSED BOTTOM, 16 CKT, DOUBLE ROW VERTICAL, MINI UNIVERSAL MATE-N-LOK
CHK: R JONES	29JUL2003	
APP'D: R JONES	29JUL2003	SIZE: A1
PRODUCT SPEC		SCALE: 5:1
APPLICATION SPEC		SHEET: 1 OF 1
WEIGHT		REV: F1
CUSTOMER DRAWING		

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)